MAGICARD ID CARD PRINTERS	Brand Name(s): MA Product Name : Ric	AGICARD 2 Secure ID Card inter	Pr	roduct Category: "Annex 1A" roduct family: "Annex 1B"
	Date: 30	March 2006		
	Contact for further in	formation request: www.u	ltra	magicard.com
Product(s) contain(s) / has	Suk	bstances		Y/N Comments
Batteries				
External	Mercury/NiCad/Lithium			NO
Internal	Mercury/NiCad/Lithium,	/Other	1	NO See §1 for further information
				Goo 3.1 for farther information
Parts containing	Mercury		1	NO
	Lead			See §2 for further information YES PCB & Solder
	Cadmium			NO
	Printed circuit board as > 10 cm ²	sembly		YES
	Printed circuit board as From cell phones or sin	sembly milar		NO
	Liquid or paste toner ca	artridge		NO
	Hexavalent chromium			NO
	Capacitors with PCB's		1	NO See §3 for further information
	Capacitors with substar 25mm or proportionate	nces of concern* + height > ly similar volume	1	NO
				See §4 for further information
	Gas discharge lamps			NO
	Backlight lamps of LCD	D/TFT		NO
	Mercury contained in B	acklighting lamps		NO

	Plastic containing brominated flame retardants other than in Printed Circuit Assemblies		NO
	Liquid Crystal Displays with a surface greater than 100 cm ²		NO
	Asbestos		NO
	Refractory ceramic fibres		NO
	Radio-active substances	1	NO
			See §5 for further information
	Beryllium Oxide	1	NO
			See §6 for further information
	Other forms of Beryllium		NO
Compartments/units/Part not in Annex 2 and are under or with	Pressure	1	NO
			See §7 for further information
	Liquids	1	NO
			See §8 for further information
	Gasses **	1	NO
			See §9 for further information
	"Hidden" mechanical springs or other equivalent parts **	1	NO
			See §10 for further information

1	=	arrow indicates the need for the location of the compartment/substances within the
•	,	product. Location is needed at part level.

NONE

ALL VALUES MUST BE GIVEN IN METRICS

Internal Batteries

1.

Location:

Туре:			NONE
Location:			
2.	Mercury		

Substance of concern other than PCB, to be specified/addressed further in the context of EU Directive 2002/96/EC (27 January 2003)(WEEE Directive) Annex 2
 National requirements and European developments

^{**} Same need as for maintenance, service manuals and installation for safety purposes.

Location:		NONE	
4.	Capacitors with substance(s) of concern	other than PCB	
Substance	e(s):	NONE	
Location:			
5.	Radio-active substances		
Source:		NONE	
Activity:			
Location:			
6.	Beryllium oxide		
Location:		NONE	
7.	Pressure containers		
Type of cor	ntainer(s):	NONE	
Volume:			
Pressure:			
Substances	S:		
Location:			
Method of	discharge:		
8.	Liquids		
Type of liqu	uid(s):	NONE	
Volume / Weight:			
Location:			
Properties:			

Capacitors with polychlorobiphenyl (PCB)

3.

Method of	discharge:			
9.	Gasses			
Type of gasses:				
Volume / Weight:				
Pressure:				
Properties				
Location:				
Method of	discharge:			
10.	"Hidden" Mechanical springs or equivalent			
Type of ris	k:	NONE		
Location:				
Method of	handling:			
11.	Comments			